



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



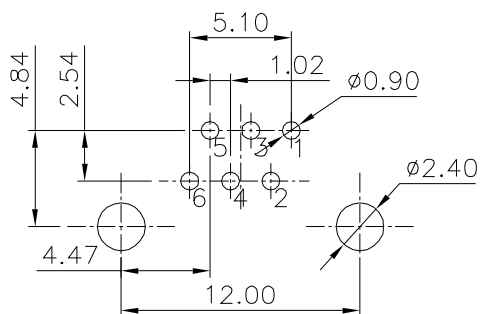
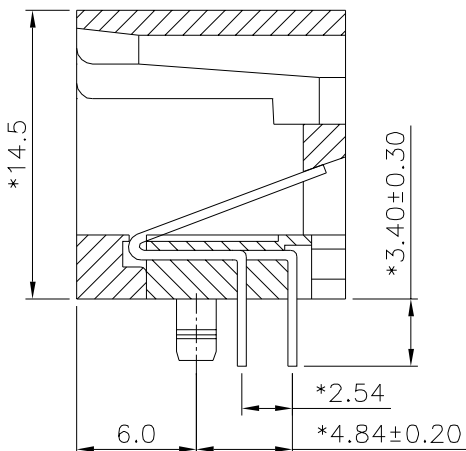
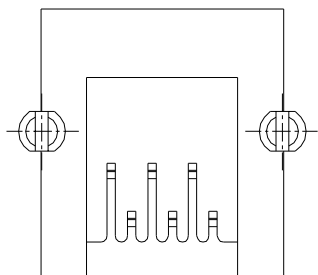
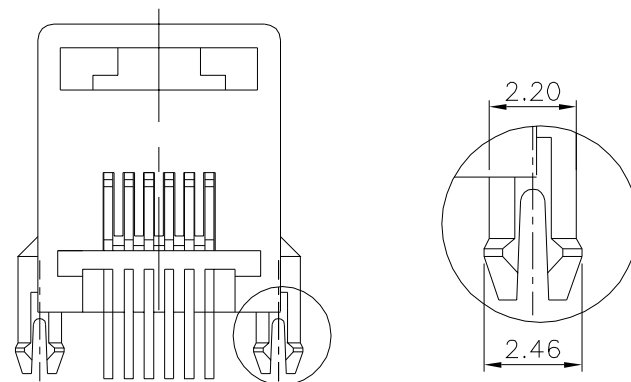
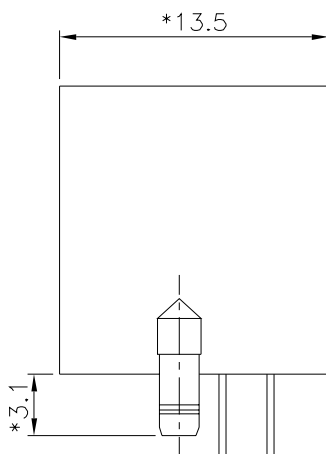
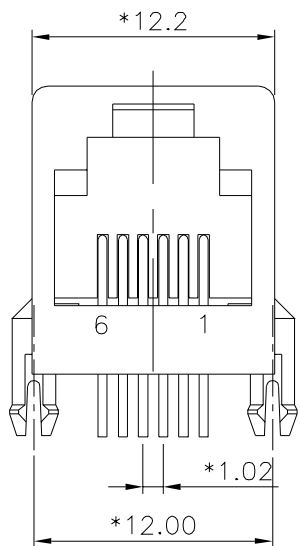
Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China





PC Board Layout T=1.6mm
Component Side Shown Tolerance±0.05mm

NOTES:

ELECTRICAL:

1. VOLTAGE RATING : 125 VAC RMS.
2. CURRENT RATING : 1.5 AMP.
3. CONTACT RESISTANCE : 45 MILLIOHMS MAX.
4. INSULATION RESISTANCE: 1000 MEGOHMS MIN @ 500 VDC.
5. DIELECTRIC STRENGTH : 1000 VAC RMS 60Hz, 1MIN.

MECHANICAL:

1. HOUSING MATERIAL : GLASS FILLED NYLON UL94V-0, GRAY
2. CONTACT MATERIAL : PHOSPHOR BRONZE ϕ 0.46mm.
3. PLATING : GOLD PLATING OVER NICKEL.
4. OPERATING LIFE : 750 CYCLES MIN.
5. PCB RETENTION PRE-SOLDER : 1 LB MIN.
6. PCB RETENTION POST-SOLDER: 10 LBS MIN.

ENVIRONMENTAL:

1. STORAGE TEMPERATURE : -40°C TO +85°C.
2. OPERATION TEMPERATURE : -40°C TO +85°C.
3. WAVE SOLDERING TEMPERATURE: 230~250°C (3~5 SECONDS)
4. RoHS COMPLIANT.

MATES WITH MODULAR PLUG CONFORMING TO

FCC PART 68, SUBPART F.

CUL FILE NO. E163191

PART NUMBER
E5566-Q0LK22-L

<small>← MM (INCH) →</small> TOLERANCES EXCEPT AS NOTED MM ± .0 ± 0.2 ± .00 ± 0.15 ± .000 ± 0.075 ± ANGLES ± 0.5		RoHS Compliant Pulse <small>A TECHNOLOG COMPANY</small> TITLE MINI L/P PCB JACK		
<small>DETACHED LISTS</small>		DFTO Cathy DATE 2006/09/11	DRAWING NO. CE553027-LC /PART NO. SEE TABLE	SIZE A3 REV 0
		SCALE: 4:1	DO NOT SCALE DRAWING	SHEET 1 OF 1